

In the layout footprint of MSD1260-472 was given instead of Wruth's 744273102

1.8V@1.0A

2.5V@1.0A

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H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

H9 SJ-5303 (CLEAR) H10 SJ-5303 (CLEAR) H11 SJ-5303 (CLEAR) H12 SJ-5303 (CLEAR)

DNP FID1 DNP FID2 DNP FID3

PCB Number: PMP9492  
PCB Rev: E1

PCB  
LOGO  
Texas Instruments

You should delete the nylon screws/standoffs and/or the bumpers as needed for your design (or substitute other parts from Hardware.IntLib). Bumpers are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

LBL1  
PCB Label  
Size: 0.65" x 0.20"

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Number: PMP9492	Rev: E1	Designed for: Public Release	Mod. Date: 11/4/2014
SVN Rev: Not in version control	Sheet Title:	Project Title: SMPS design for Rear Camera ADAS	Sheet: 1 of 1
Drawn By:	File: PMP9492_Hardware.SchDoc	Assembly Variant: 001	Size: B
Engineer: Ambresh Tripathi	Contact: http://www.ti.com/support		




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Revision History	
Revision	Notes

Place Block Diagram here (if appropriate) or delete this text box.  
 If using a block diagram from another tool, save the picture as a .bmp file.  
 Then, use menu Place|Drawing Tools|Graphic to insert the .bmp file on the schematic.

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Number: <a href="#">PMP9492</a>	Rev: <a href="#">E1</a>	Designed for: <a href="#">Public Release</a>	Mod. Date: <a href="#">11/4/2014</a>
SVN Rev: <a href="#">Not in version control</a>	Assembly Variant: <a href="#">001</a>	Project Title: <a href="#">SMPS design for Rear Camera ADAS</a>	Sheet: <a href="#">1</a> of <a href="#">1</a>
Drawn By: <a href="#">Ambreesh Tripathi</a>	File: <a href="#">PMP9492_Cover Sheet.SchDoc</a>	Size: <a href="#">B</a>	 <b>TEXAS INSTRUMENTS</b>
Engineer: <a href="#">Ambreesh Tripathi</a>	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	<a href="http://www.ti.com">http://www.ti.com</a>	© Texas Instruments 2014

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